

Parameter	Rating	Units
Load Voltage	250	V _P
Load Current	250	mA _{rms} / mA _{DC}
On-Resistance (max)	7	Ω

Features

- 3750V_{rms} Input/Output Isolation
- Low Drive Power Requirements (TTL/CMOS Compatible)
- No Moving Parts
- High Reliability
- · Arc-Free With No Snubbing Circuits
- FCC Compatible
- VDE Compatible
- No EMI/RFI Generation
- Small 8-Pin Packages
- · Machine Insertable, Wave Solderable
- Tape & Reel Versions Available

Applications

- Telecommunications
 - · Telecom Switching
 - Tip/Ring Circuits
 - Modem Switching (Laptop, Notebook, Pocket Size)
 - Hook Switch
 - Dial Pulsing
 - Ground Start
 - Ringing Injection
- Instrumentation
 - Multiplexers
 - Data Acquisition
 - · Electronic Switching
 - I/O Subsystems
- · Meters (Watt-Hour, Water, Gas)
- Medical Equipment-Patient/Equipment Isolation
- Security
- Aerospace
- Industrial Controls

Description

The PAA150 is a dual, 250V, 250mA, 7Ω , normally open (1-Form-A) relay that uses optically coupled MOSFET technology to provide $3750V_{rms}$ of input to output isolation.

Its optically coupled outputs, which use the patented OptoMOS architecture, are controlled by a highly efficient GaAlAs infrared LED.

This high performance leader provides a more cost effective solution where very low on-resistance is required, but enhanced peak load voltage is not required.

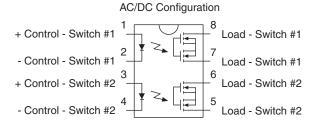
Approvals

- UL Recognized Component: File E76270
- CSA Certified Component: Certificate 1175739
- EN/IEC 60950-1 Certified Component: TUV Certificate B 09 07 49410 004

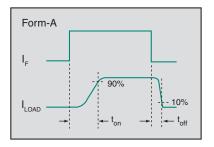
Ordering Information

Part #	Description
PAA150	8-Lead DIP (50/tube)
PAA150P	8-Lead Flatpack (50/tube)
PAA150PTR	8-Lead Flatpack (1000/Reel)
PAA150S	8-Lead Surface Mount (50/tube)
PAA150STR	8-Lead Surface Mount (1000/Reel)

Pin Configuration



Switching Characteristics of Normally Open Devices











Absolute Maximum Ratings @ 25°C

Parameter	Ratings	Units
Blocking Voltage	250	V_P
Reverse Input Voltage	5	V
Input Control Current	50	mA
Peak (10ms)	1	А
Input Power Dissipation ¹	150	mW
Total Power Dissipation ²	800	mW
Isolation Voltage, Input to Output	3750	V_{rms}
Operational Temperature	-40 to +85	°C
Storage Temperature	-40 to +125	°C

¹ Derate linearly 1.33 mW / °C

Absolute Maximum Ratings are stress ratings. Stresses in excess of these ratings can cause permanent damage to the device. Functional operation of the device at conditions beyond those indicated in the operational sections of this data sheet is not implied.

Electrical Characteristics @ 25°C

Parameter	Conditions	Symbol	Min	Тур	Max	Units
Output Characteristics						
Load Current						
Continuous *	-	IL	-	-	250	$\rm mA_{\rm rms}$ / $\rm mA_{\rm DC}$
Peak	10ms	I _{LPK}	-	-	±500	mA _P
On-Resistance, AC/DC Configuration	I _L =250mA	R _{ON}	-	-	7	Ω
Off-State Leakage Current	V _L =250V _P	I _{LEAK}	-	-	1	μΑ
Switching Speeds						
Turn-On	-EmA \/ -10\/	t _{on}	-	-	2.5	ma
Turn-Off	I _F =5mA, V _L =10V	t _{off}	-	-	0.5	ms
Output Capacitance	V _L =50V, f=1MHz	C _{OUT}	-	110	-	pF
Input Characteristics						
Input Control Current to Activate	I _L =250mA	I _F	-	-	5	mA
Input Control Current to Deactivate	-	I _F	0.4	0.7	-	mA
Input Voltage Drop	I _F =5mA	V_{F}	0.9	1.2	1.4	V
Reverse Input Current	V _R =5V	I _R	-	-	10	μΑ
Common Characteristics						
Capacitance Input to Output	-	C _{I/O}	-	3	-	pF

^{*}NOTE: If both poles operate simultaneously, then load current must be derated in order not to exceed the package power dissipation value.

² Derate linearly 6.67 mW / °C



Manufacturing Information

Moisture Sensitivity

All plastic encapsulated semiconductor packages are susceptible to moisture ingression. IXYS Integrated Circuits Division classified all of its plastic encapsulated devices for moisture sensitivity according to the latest version of the joint industry standard, IPC/JEDEC J-STD-020, in force at the time of product evaluation. We test all of our products to the maximum conditions set forth in the standard, and guarantee proper operation of our devices when handled according to the limitations and information in that standard as well as to any limitations set forth in the information or standards referenced below.

Failure to adhere to the warnings or limitations as established by the listed specifications could result in reduced product performance, reduction of operable life, and/or reduction of overall reliability.

This product carries a **Moisture Sensitivity Level (MSL) rating** as shown below, and should be handled according to the requirements of the latest version of the joint industry standard **IPC/JEDEC J-STD-033**.

Device	Moisture Sensitivity Level (MSL) Rating
PAA150 / PAA150S / PAA150P	MSL 1

ESD Sensitivity



This product is ESD Sensitive, and should be handled according to the industry standard JESD-625.

Reflow Profile

This product has a maximum body temperature and time rating as shown below. All other guidelines of **J-STD-020** must be observed.

Device	Maximum Temperature x Time	
PAA150 / PAA150S	250°C for 30 seconds	
PAA150P	260°C for 30 seconds	

Board Wash

IXYS Integrated Circuits Division recommends the use of no-clean flux formulations. However, board washing to remove flux residue is acceptable. Since IXYS Integrated Circuits Division employs the use of silicone coating as an optical waveguide in many of its optically isolated products, the use of a short drying bake could be necessary if a wash is used after solder reflow processes. Chlorine- or Fluorine-based solvents or fluxes should not be used. Cleaning methods that employ ultrasonic energy should not be used.



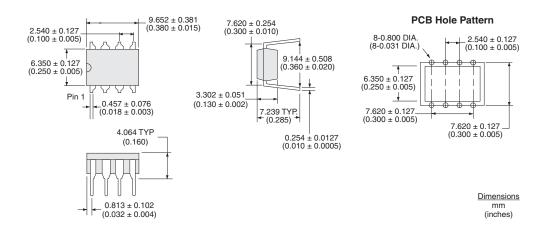




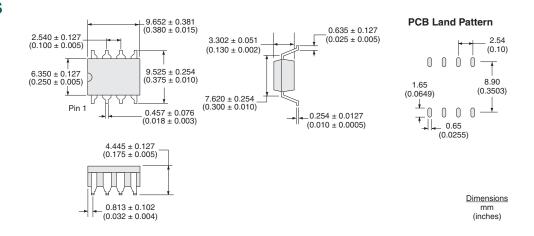


Mechanical Dimensions

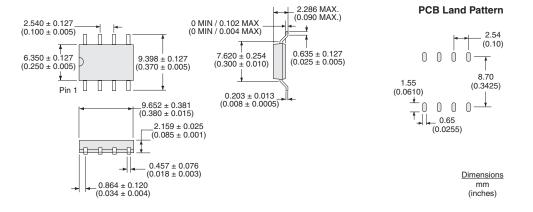
PAA150



PAA150S

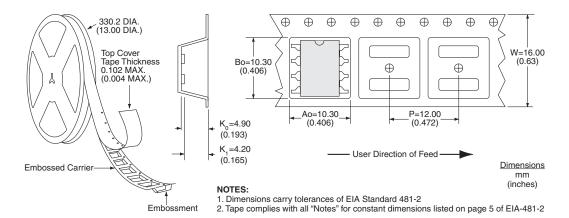


PAA150P

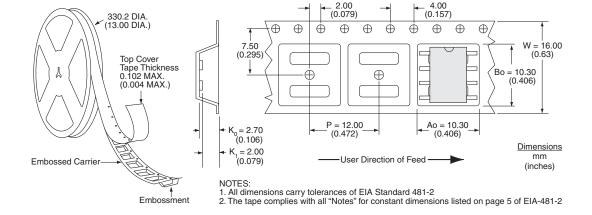




PAA150STR Tape & Reel



PAA150PTR Tape & Reel



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